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| PPLICATION NO. | 1 | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO |
|----------------|--------------------------|------------------|----------------------|-------------------------|-----------------|
| 10/809,203 | 03/25/2004 | | Toshimitsu Hirai | 9319S-000716 | 5989 |
| 27572 | 7590 | 09/06/2006 | | EXAMINER | |
| HARNESS | , DICKE | EY & PIERCE, P.L | KIM, SU C | | |
| P.O. BOX 8 | OX 828 | | | | PAPER NUMBER |
| DLOOMI IL | MILLO IIILLO, IVII 40000 | | | 2823 | |
| | | | | DATE MAILED: 09/06/2006 | |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | | Application No. | Applicant(s) | | | | |
|---|---|---|---|--|--|--|--|
| | | 10/809,203 | HIRAI, TOSHIMITSU | | | | |
| Office Action Summary | | Examiner | Art Unit | | | | |
| | | Su C. Kim | 2823 | | | | |
| Period fo | The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply | | | | | | |
| A SH | ORTENED STATUTORY PERIOD FOR REPLY | | | | | | |
| - Exter after - If NO - Failur Any r | CHEVER IS LONGER, FROM THE MAILING DA sions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. period for reply is specified above, the maximum statutory period w re to reply within the set or extended period for reply will, by statute, eply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b). | 66(a). In no event, however, may a reply be timiled apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE. | nely filed the mailing date of this communication. D (35 U.S.C. § 133). | | | | |
| Status | | | | | | | |
| 1)⊠ | Responsive to communication(s) filed on 22 Ju | ne 2006. | | | | | |
| 2a)⊠ | This action is FINAL . 2b) This action is non-final. | | | | | | |
| 3) | Since this application is in condition for allowance except for formal matters, prosecution as to the merits is | | | | | | |
| | closed in accordance with the practice under E | x parte Quayle, 1935 C.D. 11, 45 | i3 O.G. 213. | | | | |
| Dispositi | on of Claims | • | | | | | |
| 4) 🖾 | 4)⊠ Claim(s) <u>1-5 and 9-13</u> is/are pending in the application. | | | | | | |
| | 4a) Of the above claim(s) is/are withdrawn from consideration. | | | | | | |
| | 5) Claim(s) is/are allowed. | | | | | | |
| · | Claim(s) <u>1,5,9 and 10</u> is/are rejected. | | | | | | |
| · · · · · · · · · · · · · · · · · · · | ☑ Claim(s) <u>2-4,12 and 13</u> is/are objected to. ☑ Claim(s) are subject to restriction and/or election requirement. | | | | | | |
| <u>ال</u> | are subject to restriction and/or | election requirement. | | | | | |
| Applicati | on Papers | | | | | | |
| 9) 🗌 . | The specification is objected to by the Examine | r. | | | | | |
| | 10)⊠ The drawing(s) filed on <u>25 March 2004</u> is/are: a)⊠ accepted or b)⊡ objected to by the Examiner. | | | | | | |
| | Applicant may not request that any objection to the o | | | | | | |
| 11) 🔲 - | Replacement drawing sheet(s) including the correction The oath or declaration is objected to by the Ex- | • | , , | | | | |
| Priority u | nder 35 U.S.C. § 119 | | | | | | |
| 12)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a)⊠ All b)□ Some * c)□ None of: | | | | | | | |
| | 1. Certified copies of the priority documents have been received. | | | | | | |
| • | 2. Certified copies of the priority documents have been received in Application No | | | | | | |
| | 3. Copies of the certified copies of the priority documents have been received in this National Stage | | | | | | |
| | application from the International Bureau | • | | | | | |
| * See the attached detailed Office action for a list of the certified copies not received. | | | | | | | |
| | | | | | | | |
| | | | | | | | |
| Attachment | t(s) e of References Cited (PTO-892) | 4) 🗖 Image in 6 | (DTO 412) | | | | |
| 2) Notice | e of Draftsperson's Patent Drawing Review (PTO-948) | 4) Linterview Summary Paper No(s)/Mail Da | te | | | | |
| | nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) r No(s)/Mail Date 6/20/2006. | 5) Notice of Informal P 6) Other: | atent Application (PTO-152) | | | | |

DETAILED ACTION

Response to Amendment

1. Applicant's amendment was received on 6/22/2006, and has been entered and made of record. Currently claims 1-5, 9-10, & 12-13 are pending.

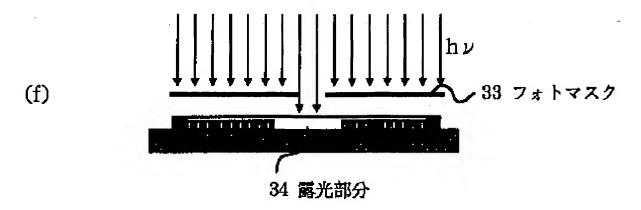
Response to Arguments

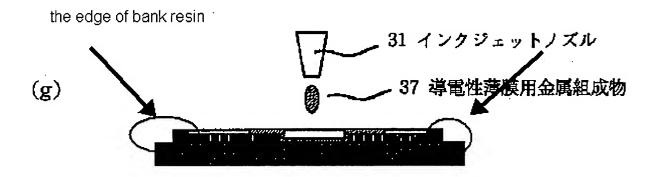
2. With respect to claims rejection under 35 U.S.C. 102(b), applicant amended new claim limitation(s) that "and a step of removing the banks" as recited in claim 1 and "removing the bank after the conductive layer and element electrodes are formed" as recited in claim 9. However, new claim limitation(s) does not overcome the rejection under the 35 U.S.C102(b) with Kamishiro Kazuhiro (JP 2000-243254, hereafter Kamishiro)

Kamishiro discloses removing banks (Drawing 2(a), Resin constituent layer 32) after the conductive layer (Drawing 2 (d), Metal constituent for electrodes 35) and element electrode are formed as seen in Drawing 3(g)-3(i)

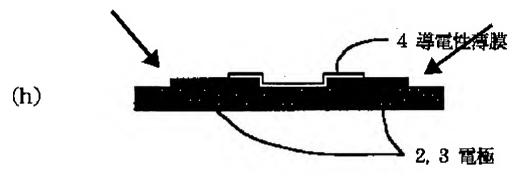
Kamishiro discloses a step of removing banks in Drawing 3(f) - 3(i) below

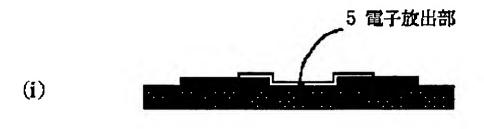
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after forming electrode(37), the bank region has been removed.





Therefore, the rejection of claims 1 and 9 under 35 U.S.C. 102(b) is deemed proper.

In addition, for the rejection of claims 2-5 & 10,12, & 13 the *prima facie* case of obviousness has been met and the rejection under 35 U.S.C. § 103 is deemed proper.

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 1, 5, 9, 10, & 11 are rejected under 35 U.S.C. 102(b) as being anticipated by Kamishiro Kazuhiro (JP 2000-243254) ('hereafter Kamishro')

Pertaining claim 1, <u>Kamishro</u> discloses a method for manufacturing electron emitters by providing pairs of element electrodes, and conductive layers (Drawing 3(h), 2 & 3) connecting the element electrodes (Drawing 3(h), 5) to each other on a substrate (Drawing 2(a), 1), the method comprising:

a step of forming banks (Drawing 2(a)-(c), 34) surrounding electrode-forming regions for forming the element electrodes (Drawing 3(h), 2 & 3) and conductive layer-forming regions 4 for forming the conductive (Drawing, 2 & 3)

a step of discharging first droplets toward the electrode-forming regions (Drawing 2 (a)-2(e));

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and a step of discharging second droplets toward the conductive layer-forming regions (Drawing 3-(g)); and

a step of removing bank(Drawing 3(g)-3(i))

Pertaining claim 5, as applied to claim 1, <u>Kamishro</u> discloses an electron emitter manufactured by the method according to claim 1. (See the rejection on claim 1)

Pertaining claim 9, <u>Kamishro</u> discloses a method for manufacturing an electron emitter comprising:

defining a pair of spaced apart electrode (Drawing 3(i), 2 & 3) forming regions on a substrate (Drawing 2 (c)-(d));

defining a conductive layer-forming region on the substrate, the conductive layer 4 forming region interconnecting the electrode-forming regions (Drawing 3 (h));

forming a bank (Drawing 2(c), 32) encircling the electrode-forming regions and the conductive layer forming region (Drawing 2(c));

discharging first droplets (Drawing 2(d), 35) toward the electrode-forming regions to form a pair of element electrodes (Fig. 2 (e)); and

discharging second droplets (Drawing 3(g), 37) toward the conductive layerforming regions to form a conductive layer connecting the element electrodes to each
other (Drawing 3(g)); and

removing the bank after the conductive layer and element electrodes are formed(Drawing 3(f)-(i) and details on paragraph 2 above)

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Pertaining claim 10, as applied to claim 9 above, <u>Kamishro</u> discloses the method of claim 9, further comprising treating a portion of the conductive layer (Drawing 3(g), 4) to form an electron-emitting section (Drawing 3(g), 5).

Allowable Subject Matter

5. Claims 2-4 & 12-13 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Su C. Kim whose telephone number is (571) 272-5972. The examiner can normally be reached on Monday - Thursday, 9:00AM to 7:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew S. Smith can be reached on (571) 272-1907. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

BNOOK KEBEDE PRIMARY EXAMINER Application/Control Number: 10/809,203

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Su C. Kim 8/28/2006